CMOS Linear Integrated Circuits Silicon Monolithic

TC75W70L8X

1. Functional Description

Dual Comparator

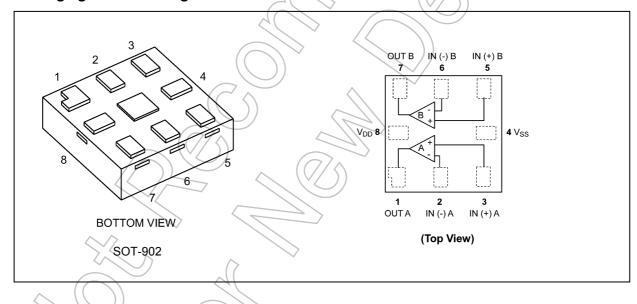
2. General

This is a CMOS Input/Output full swing comparator with low operating voltage and low supply current. The comparator have low operating voltage V_{DD} = 1.3 V to 5.5 V and low supply current I_{DD} = 26 μA (typ.) @ V_{DD} = 1.5 V. Output circuit type is push-pull circuit. The package SOT-902 (1.6 mm \times 1.6 mm, t: 0.55 mmMAX) is ultra small, so that it is ideal for high-density assembly such as cellular phone.

3. Features

- (1) Dual circuit, Input/Output full swing comparator
- (2) Low operating voltage: $V_{DD} = 1.3 \text{ V}$ to 5.5 V
- (3) Low supply current: $I_{DD} = 26 \mu A \text{ (typ.)} (@V_{DD} = 1.5 \text{ V})$
- (4) Ultra Small package: SOT-902 (1.6 mm \times 1.6 mm, t = 0.55 mmMAX)
- (5) Low input bias current: 1 pA (typ.)
- (6) Push-pull output circuit
- (7) Single power supply operation

4. Packaging and Pin Assignment





5. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{DD}		±3.0 or 6.0	V
Differential input voltage	ΔV_{IN}		±6.0	V
Input voltage	V _{IN}		V _{SS} to V _{DD}	V
Output current	I _{OUT}		±35	mA
Power dissipation	P _D	(Note 1)	300	mW
Operating temperature	T _{opr}		-40 to 85	°C
Storage temperature	T _{stg}		-55 to 125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: Since this device is susceptible to latch-up, a phenomenon inherent to CMOS devices, follow these considerations:

- Don't raise the voltage level of the output pins above V_{DD} or lower it below V_{SS}. Consider the power-on timing as well.
- Ensure that any abnormal noise is not introduced into the device.

Note 1: Mounted on an FR4 board.

6. Operating Ratings (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{DD}		1.3 to 5.5	V
Supply voltage	V _{DD} ,V _{SS}		±0.65 to ±2.75	V

7. Electrical Characteristics

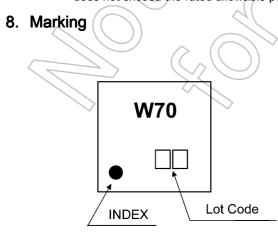
7.1. $V_{DD} = 3.0 \text{ V}$ (Unless otherwise specified, $T_a = 25 \text{ °C}$, $V_{SS} = GND$)

Characteristics	Symbol	Note	Test Condition	Test Circuit	Min	Тур.	Max	Unit
Input offset voltage	V _{IO}		_	_		±1	±6	mV
Input offset current	I _{IO}		_			1		pА
Input bias current	l _l		_	_	(F)	1		pА
Common-mode input voltage range	V _{ICM}		_	_	0)/_	3.0	V
Supply current	I _{DD}	(Note 1)	_	Fig.10.3	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	27	47	μА
Sink current	I _{SINK}		V _{OL} = 0.5 V	Fig.10.2	9)	18	_	mA
Source current	I _{SOURCE}		V _{OH} = 2.5 V	Fig.10.1	\mathcal{I}	15		mA
Low-level output voltage	V _{OL}		I _{SINK} = 5.0 mA	Fig.10.2	> —	0.15	0.30	V
High-level output voltage	V _{OH}		I _{SOURCE} = 5.0 mA	Fig.10.1	2.70	2.85	_	V
Propagation delay time (L/H)	t _{PLH}		Over drive = 100 mV	Fig.10.4	_	400	/	ns
Propagation delay time (H/L)	t _{PHL}		Over drive = 100 mV	Fig.10.4	_ /	800		ns
Response time (low-to-high)	t _{TLH}		Over drive = 100 mV	Fig.10.4	-6	14	> _	ns
Response time (high-to-low)	t _{THL}		Over drive = 100 mV	Fig.10.4)(14) —	ns

7.2. V_{DD} = 1.5 V (Unless otherwise specified, T_a = 25 °C, V_{SS} = GND)

Characteristics	Symbol	Note	Test Condition	Test Circuit	Min	Тур.	Max	Unit
Input offset voltage	V _{IO}		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	(\wedge)))—	±1	±6	mV
Input offset current	I _{IO}	4	-		/ _	1	_	pА
Input bias current	l _l		\	17	_	1	_	pА
Common-mode input voltage range	V _{ICM}			17-	0	_	1.5	V
Supply current	I _{DD}	(Note 1)	_	Fig.10.3	_	26	46	μА
Sink current	ISINK	\wedge	V _{OL} = 0.5 V	Fig.10.2	2.5	6.0	_	mA
Source current	ISOURCE))	V _{OH} = 1.0 V	Fig.10.1	1.5	5.0	_	mA
Low-level output voltage	V _{QL}		I _{SINK} = 1.5 mA	Fig.10.2	_	0.10	0.25	V
High-level output voltage	VoH		I _{SOURCE} = 1.5 mA	Fig.10.1	1.25	1.40	_	V
Propagation delay time (L/H)	t _{PLH}	^	Over drive = 100 mV	Fig.10.4	_	400	_	ns
Propagation delay time (H/L)	7 t _{PHL}		Over drive = 100 mV	Fig.10.4	_	720	_	ns
Response time (low-to-high)	t _{TLH} /		Over drive = 100 mV	Fig.10.4	_	20	_	ns
Response time (high-to-low)	t _{THL}		Over drive = 100 mV	Fig.10.4	_	33	_	ns

Note 1: The current consumption of the device increases with its operating frequency. Ensure that its power dissipation does not exceed the rated allowable power dissipation.



(Top View)

9. Characteristics Curves (Note)

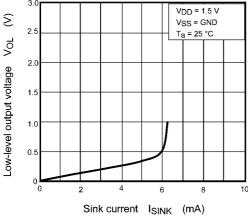


Fig. 9.1 V_{OL} - I_{SINK}

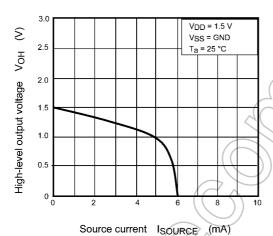
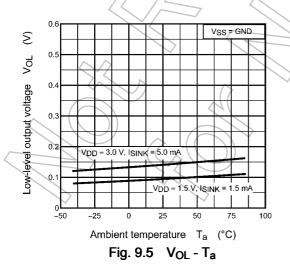


Fig. 9.3 VOH - ISOURCE



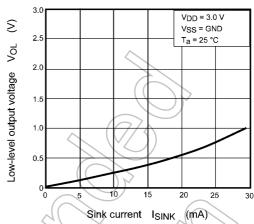


Fig. 9.2 Vol - Isink

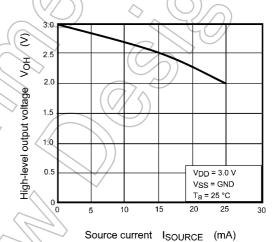


Fig. 9.4 VOH - ISOURCE

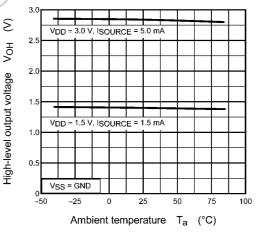


Fig. 9.6 V_{OH} - T_a

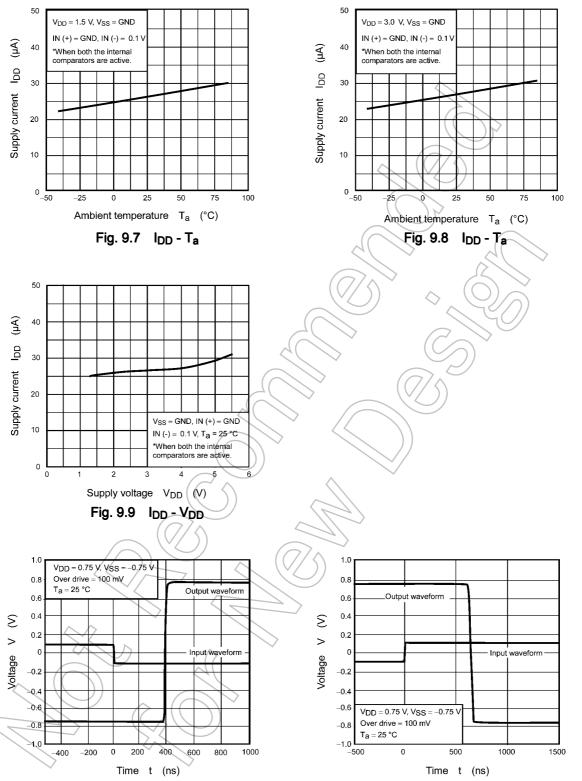
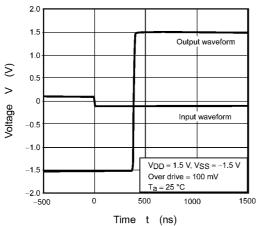


Fig. 9.10 Propagation delay time (L/H) t_{PLH}

Fig. 9.11 Propagation delay time (H/L) t_{PHL}





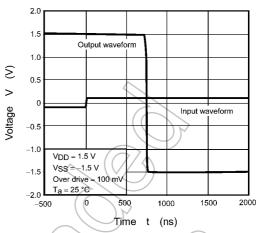


Fig. 9.13 Propagation delay time (H/L) t_{PHL}

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





10. Test Circuits

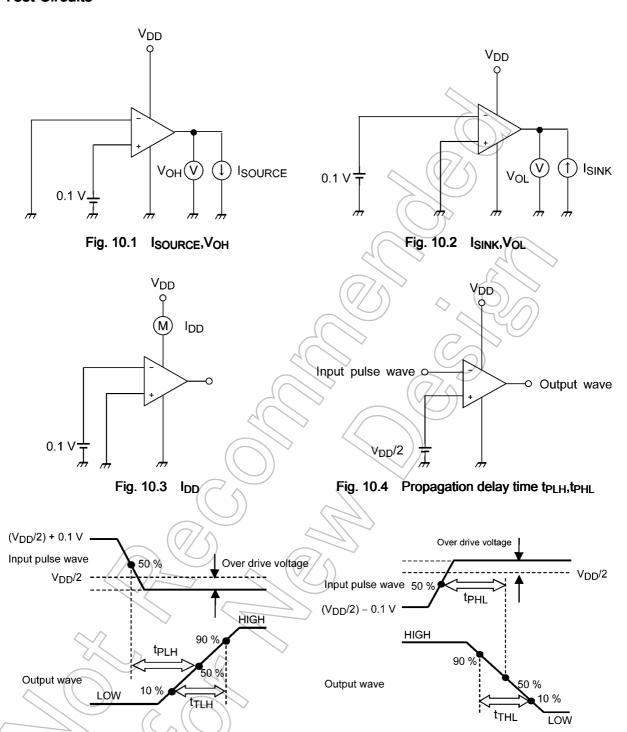


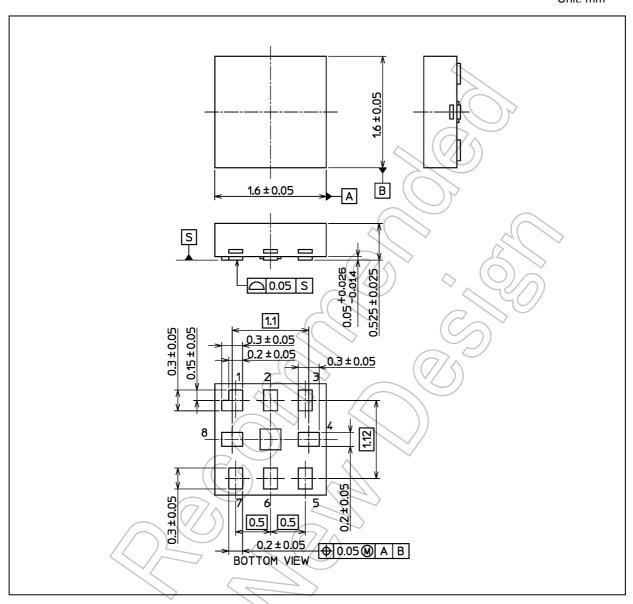
Fig. 10.5 Propagation delay time (L/H) t_{PLH} wave Fig. 10.6 Propagation delay time (H/L) t_{PHL} wave

Rev.1.0

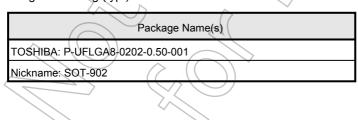


Package Dimensions

Unit: mm



Weight: 0.0031 g (typ.)



Rev.1.0



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